

NICHIA CORPORATION

SPECIFICATIONS FOR WHITE LED

NVSW119DT

- Pb-free Reflow Soldering Application
- Built-in ESD Protection Device
- RoHS Compliant



SPECIFICATIONS

(1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	I_F	1800	mA
Pulse Forward Current	I_{FP}	2400	mA
Allowable Reverse Current	I_R	85	mA
Power Dissipation	P_D	5.94	W
Operating Temperature	T_{opr}	-40~100	°C
Storage Temperature	T_{stg}	-40~100	°C
Junction Temperature	T_J	150	°C

* Absolute Maximum Ratings at $T_J=25^{\circ}\text{C}$.

* I_{FP} conditions with pulse width $\leq 10\text{ms}$ and duty cycle $\leq 10\%$.

* For I_F and I_{FP} , see the "DERATING CHARACTERISTICS" of this specification.

(2) Initial Electrical/Optical Characteristics

Item		Symbol	Condition	Typ	Max	Unit
Forward Voltage		V_F	$I_F=700\text{mA}$	2.96	-	V
			$I_F=350\text{mA}$	2.85	-	
R70	Luminous Flux (Chromaticity Coordinate1)	Φ_v	$I_F=700\text{mA}$	334	-	lm
			$I_F=350\text{mA}$	177	-	
	Luminous Intensity (Chromaticity Coordinate1)	I_v	$I_F=700\text{mA}$	114	-	cd
			$I_F=350\text{mA}$	60	-	
	Color Rendering Index (Chromaticity Coordinate1)	R_a	$I_F=700\text{mA}$	73	-	-
Chromaticity Coordinate1	x	-	$I_F=700\text{mA}$	0.3818	-	-
	y		$I_F=700\text{mA}$	0.3797	-	
R70	Luminous Flux (Chromaticity Coordinate2)	Φ_v	$I_F=700\text{mA}$	336	-	lm
			$I_F=350\text{mA}$	178	-	
	Luminous Intensity (Chromaticity Coordinate2)	I_v	$I_F=700\text{mA}$	115	-	cd
			$I_F=350\text{mA}$	61	-	
	Color Rendering Index (Chromaticity Coordinate2)	R_a	$I_F=700\text{mA}$	73	-	-
Chromaticity Coordinate2	x	-	$I_F=700\text{mA}$	0.3447	-	-
	y		$I_F=700\text{mA}$	0.3553	-	
Thermal Resistance		$R_{\theta JS}$	-	4.2	6.4	°C/W

* Characteristics at $T_J=25^{\circ}\text{C}$ and measured in pulse mode.

* Optical Characteristics as per CIE 127:2007 standard.

* Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.

* $R_{\theta JS}$ is the thermal resistance from the junction to the T_S measurement point.

* $R_{\theta JS}$ is measured using the Dynamic Mode detailed in JESD51-1.

RANKS

Item	Rank		Condition	Min	Max	Unit
Forward Voltage	M1		$I_F=700\text{mA}$	3.1	3.3	V
	L2			2.9	3.1	
	L1			2.7	2.9	
Luminous Flux	D340		$I_F=700\text{mA}$	340	360	lm
	D320			320	340	
	D300			300	320	
	D280			280	300	
Color Rendering Index	R70	R_a	$I_F=700\text{mA}$	70	-	-

Color Ranks($I_F=700\text{mA}$)

The color ranks have chromaticity ranges within 3-step MacAdam ellipse.

		Rank sm273	Rank sm303	Rank sm403	Rank sm503
Color Temperature (Unit: K)	T_{CP}	2700	3000	4000	5000
Center Point	x	0.4578	0.4338	0.3818	0.3447
	y	0.4101	0.4030	0.3797	0.3553
Minor Axis	a	0.004056	0.004107	0.004071	0.003555
Major Axis	b	0.007872	0.008391	0.009282	0.008418
Ellipse Rotation Angle	Φ	-36.05	-36.00	-35.95	-31.78

The color ranks have chromaticity ranges within 5-step MacAdam ellipse.

		Rank sm275	Rank sm305	Rank sm405	Rank sm505
Color Temperature (Unit: K)	T_{CP}	2700	3000	4000	5000
Center Point	x	0.4578	0.4338	0.3818	0.3447
	y	0.4101	0.4030	0.3797	0.3553
Minor Axis	a	0.006760	0.006845	0.006785	0.005925
Major Axis	b	0.013120	0.013985	0.015470	0.014030
Ellipse Rotation Angle	Φ	-36.05	-36.00	-35.95	-31.78

* Ranking at $T_j=25^\circ\text{C}$ and measured in pulse mode.

* Forward Voltage Tolerance: $\pm 0.05\text{V}$

* Luminous Flux Tolerance: $\pm 7\%$

* Color Rendering Index R_a Tolerance: ± 2

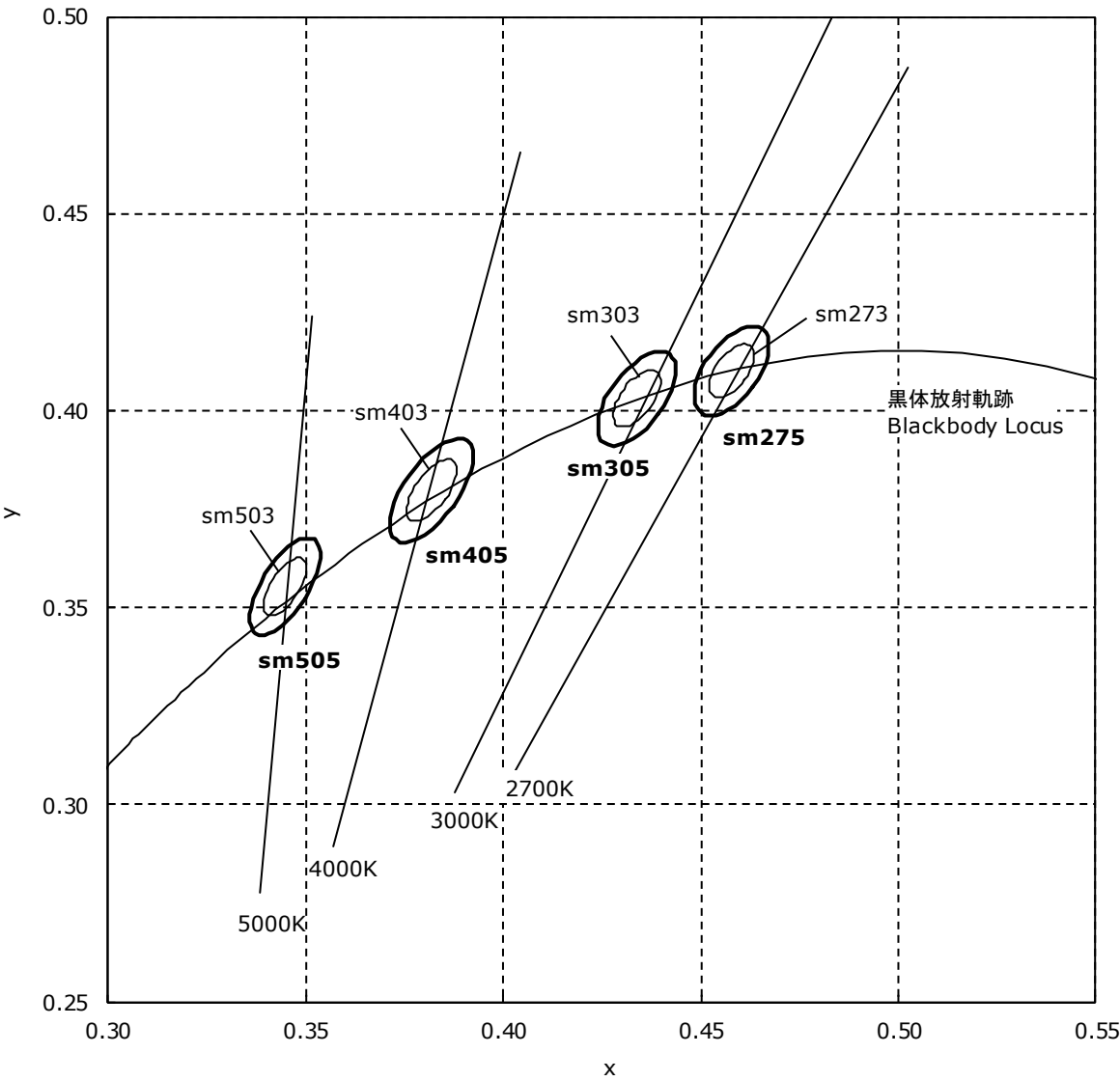
* Chromaticity Coordinate Tolerance: ± 0.005

* LEDs from the above ranks will be shipped. The rank combination ratio per shipment will be decided by Nichia.

Luminous Flux Ranks by Color Rank, Color Rendering Index Rank

Ranking by Color Coordinates, Color Rendering Index		Ranking by Luminous Flux			
		D280	D300	D320	D340
sm273,sm275,sm303,sm305		R70			
sm403,sm405,sm503,sm505		R70			

CHROMATICITY DIAGRAM

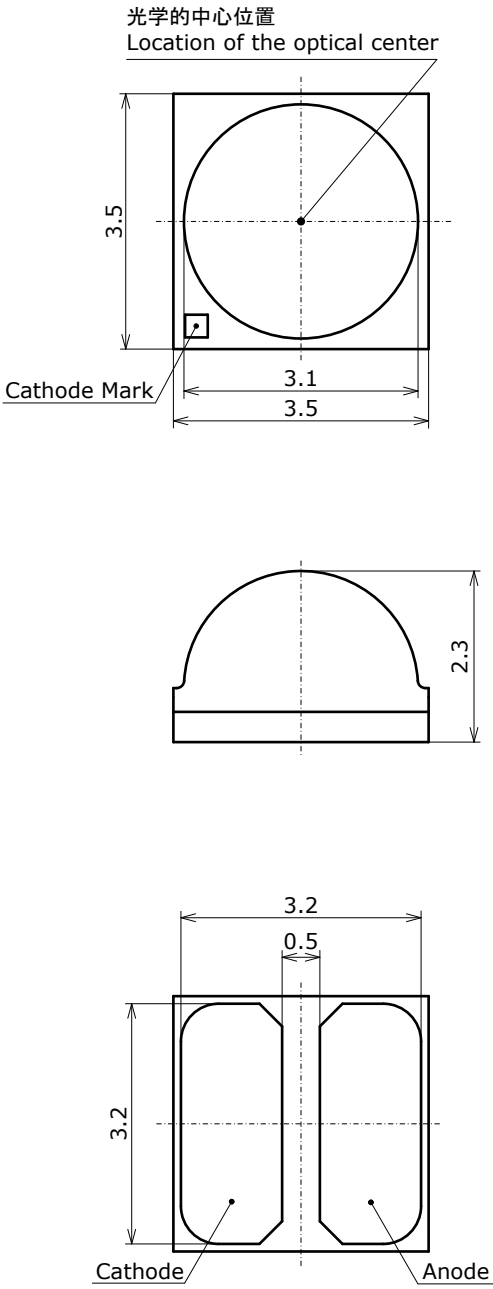


OUTLINE DIMENSIONS

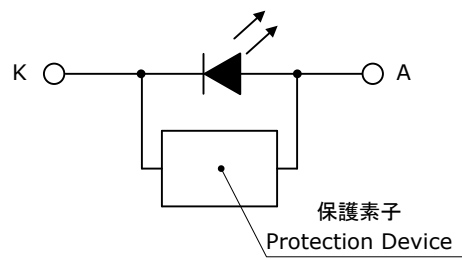
* 本製品はRoHS指令に適合しております。
This product complies with RoHS Directive.

NVSW119D
管理番号 No. STS-DA7-12639

(単位 Unit: mm, 公差 Tolerance: ±0.2)

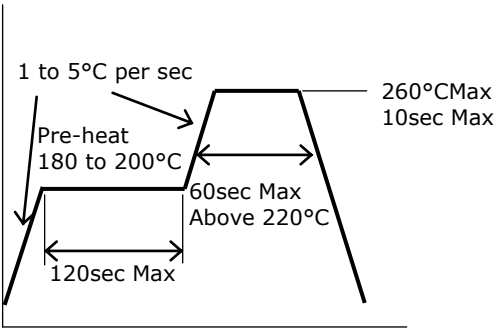


項目 Item	内容 Description
パッケージ材質 Package Materials	セラミックス Ceramics
蛍光体板材質 Phosphor sheet Materials	硬質ガラス+シリコン樹脂(蛍光体入り) Hard Glass and Silicone Resin(with phosphor)
封止樹脂材質 Encapsulating Resin Materials	シリコン樹脂(拡散剤入り) Silicone Resin(with diffuser)
レンズ材質 Lens Materials	シリコン樹脂 Silicone Resin
電極材質 Electrodes Materials	金メッキ Au-plated
質量 Weight	0.034g(TYP)



SOLDERING

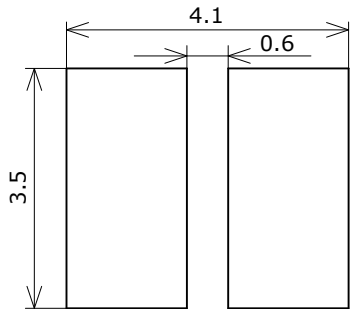
• Recommended Reflow Soldering Condition(Lead-free Solder)



• Recommended Hand Soldering Condition

Temperature	350°C Max
Soldering Time	3sec Max

• Recommended Soldering Pad Pattern



(単位 Unit: mm)

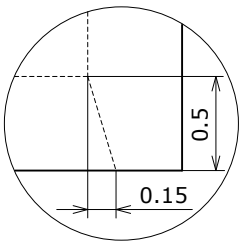
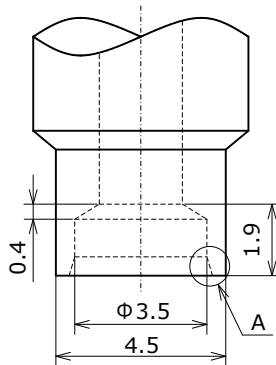
- * This LED is designed to be reflow soldered on to a PCB. If dip soldered, Nichia cannot guarantee its reliability.
- * Reflow soldering must not be performed more than twice. Hand soldering must not be performed more than once.
- * Avoid rapid cooling. Ramp down the temperature gradually from the peak temperature.
- * Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.
- * This product uses silicone resin for the lens and internal pre-coating resin; the silicone resin is soft. If pressure is applied to the lens, it may cause the lens to be damaged, chipped, and/or delaminated. If the lens is damaged, chipped and/or delaminated, then the internal connections may be damaged and the reliability may decrease. Ensure that pressure is not applied to the lens. If an automatic pick and place machine is used for the LEDs, use a pick up nozzle that does not affect the lens.

Recommended conditions:

Using a nozzle specifically designed for the LEDs is recommended (See the nozzle drawing below).

- * Ensure that the nozzle does not come in contact with the lens when it picks up an LED.

If this occurs, it may cause internal disconnection causing the LED not to illuminate.



A部拡大
Expansion of A

(単位 Unit: mm)

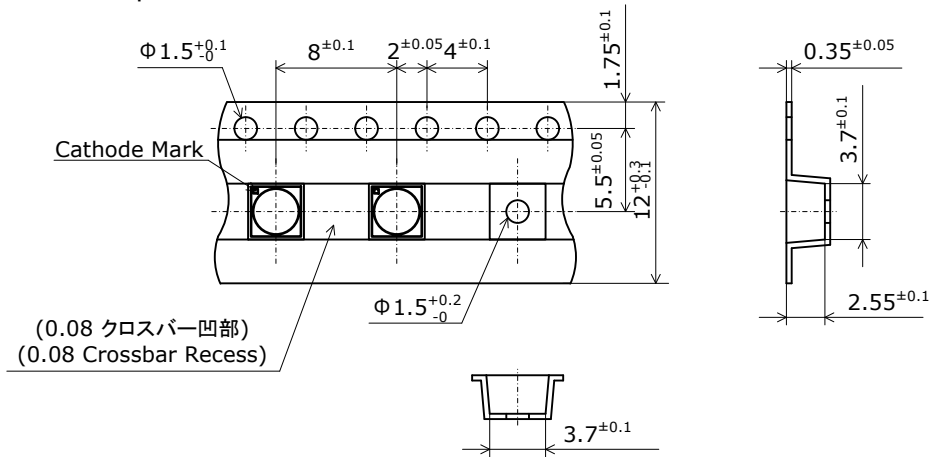
- * Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- * When soldering, do not apply stress to the LED while the LED is hot.
- * The recommended soldering pad pattern is designed for attachment of the LED without problems. When precise mounting accuracy is required, such as high-density mounting, ensure that the size and shape of the pad are suitable for the circuit design.
- * Consider factors such as the reflow soldering temperature, hand soldering temperature, etc. when choosing the solder.
- * When flux is used, it should be a halogen free flux. Ensure that the manufacturing process is not designed in a manner where the flux will come in contact with the LEDs.
- * Make sure that there are no issues with the type and amount of solder that is being used.
- * All of the electrode pads are on the backside of this product; solder connections will not be able to be seen nor confirmed by a normal visual inspection. When using the product, ensure that there are no issues with the soldering conditions.

TAPE AND REEL DIMENSIONS

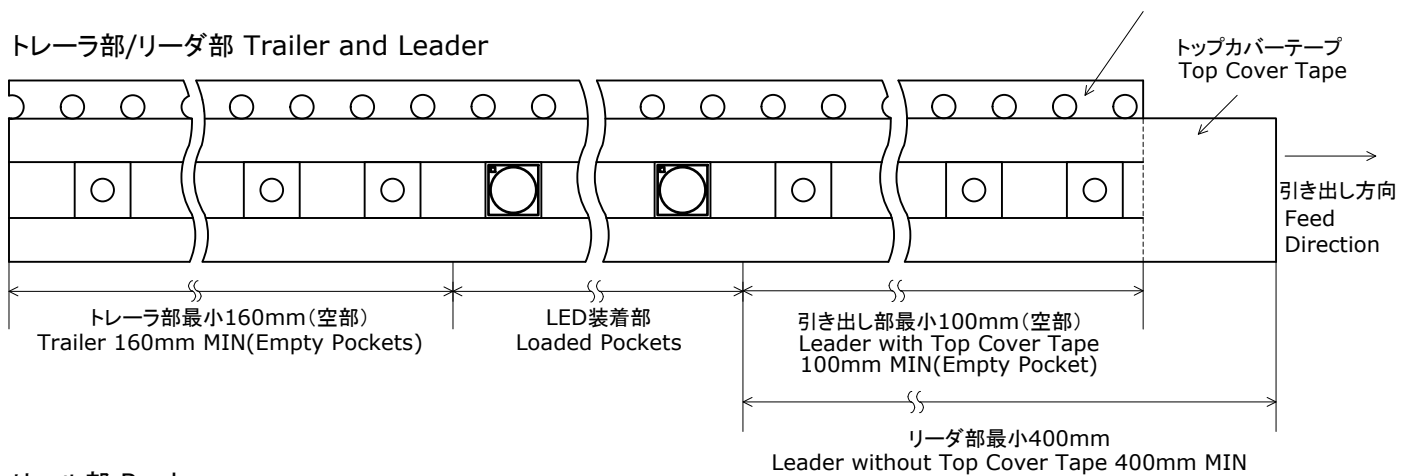
テーピング部 Tape

Nxxx119x
管理番号 No. STS-DA7-12640

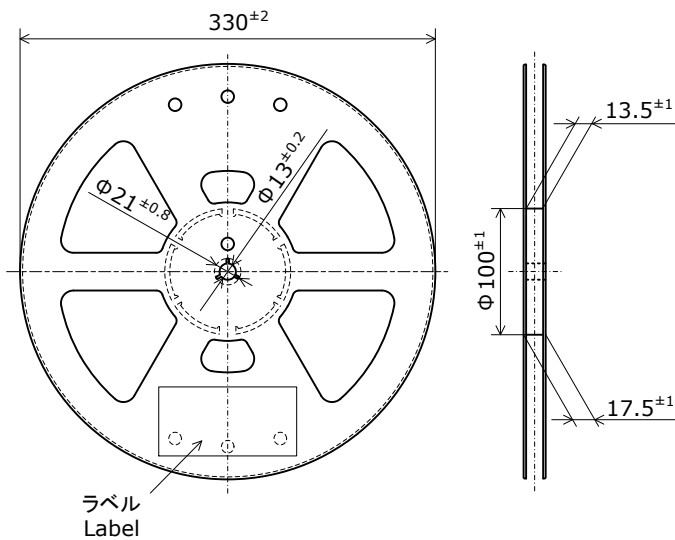
(単位 Unit: mm)



トレーラ部/リーダ部 Trailer and Leader



リール部 Reel



* 数量は1リールにつき 3000個入りです。

Reel Size: 3000pcs

* 実装作業の中断などでエンボスキャリアテープをリールに巻き取る場合、エンボスキャリアテープを強く(10N以上)締めないで下さい。

LEDがカバーテープに貼り付く可能性があります。
When the tape is rewound due to work interruptions,
no more than 10N should be applied to
the embossed carrier tape.

The LEDs may stick to the top cover tape.

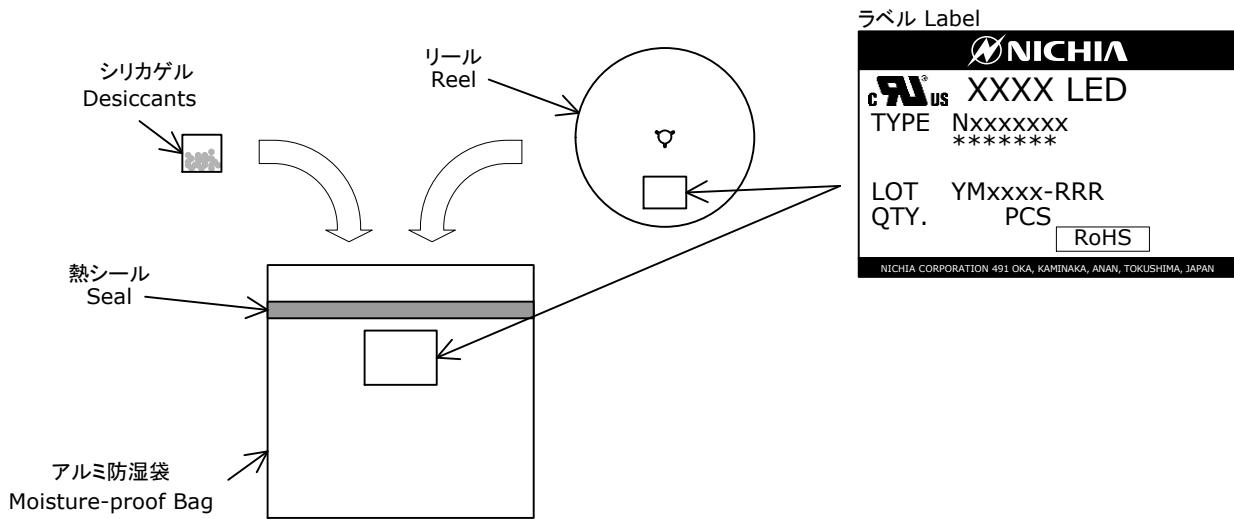
* JIS C 0806電子部品テーピングに準拠しています。

The tape packing method complies with JIS C 0806
(Packaging of Electronic Components on Continuous Tapes).

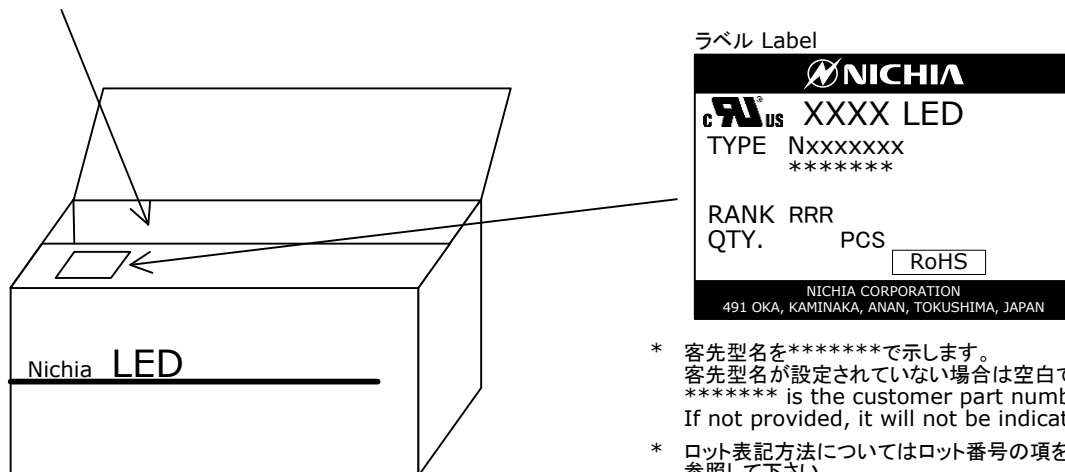
PACKAGING - TAPE & REEL

シリカゲルとともにリールをアルミ防湿袋に入れ、熱シールにより封をします。
Reels are shipped with desiccants in heat-sealed moisture-proof bags.

Nxxxxxxx
管理番号 No. STS-DA7-4989



アルミ防湿袋を並べて入れ、ダンボールで仕切ります。
Moisture-proof bags are packed in cardboard boxes with corrugated partitions.



- * 客先型名を*****で示します。
客先型名が設定されていない場合は空白です。
***** is the customer part number.
If not provided, it will not be indicated on the label.
- * ロット表記方法についてはロット番号の項を参照して下さい。
For details, see "LOT NUMBERING CODE" in this document.
- * ランク分けがない場合はランク表記はありません。
The label does not have the RANK field for un-ranked products.

- * 本製品はテーピングしたのち、輸送の衝撃から保護するためダンボールで梱包します。
Products shipped on tape and reel are packed in a moisture-proof bag.
They are shipped in cardboard boxes to protect them from external forces during transportation.
- * 取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。
Do not drop or expose the box to external forces as it may damage the products.
- * ダンボールには防水加工がされておきませんので、梱包箱が水に濡れないよう注意して下さい。
Do not expose to water. The box is not water-resistant.
- * 輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。
Using the original package material or equivalent in transit is recommended.

LOT NUMBERING CODE

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

Y - Year

Year	Y
2016	G
2017	H
2018	I
2019	J
2020	K
2021	L

M - Month

Month	M	Month	M
1	1	7	7
2	2	8	8
3	3	9	9
4	4	10	A
5	5	11	B
6	6	12	C

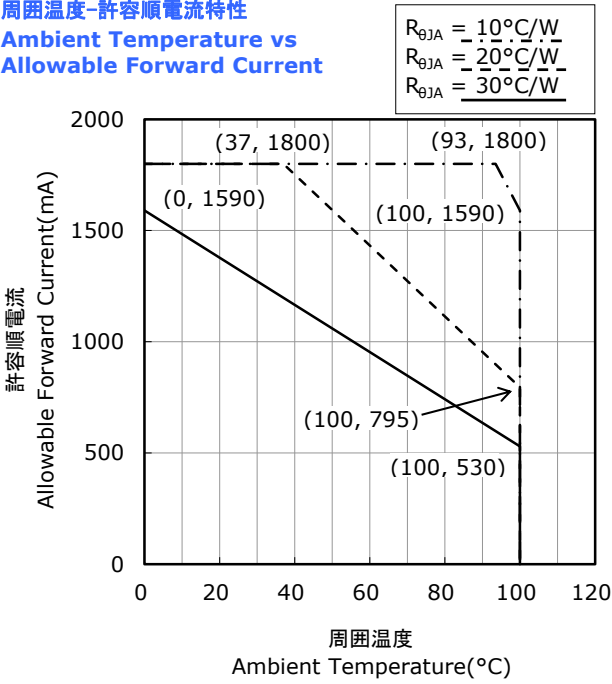
xxxx-Nichia's Product Number

RRR-Ranking by Color Coordinates, Ranking by Luminous Flux, Ranking by Forward Voltage, Ranking by Color Rendering Index

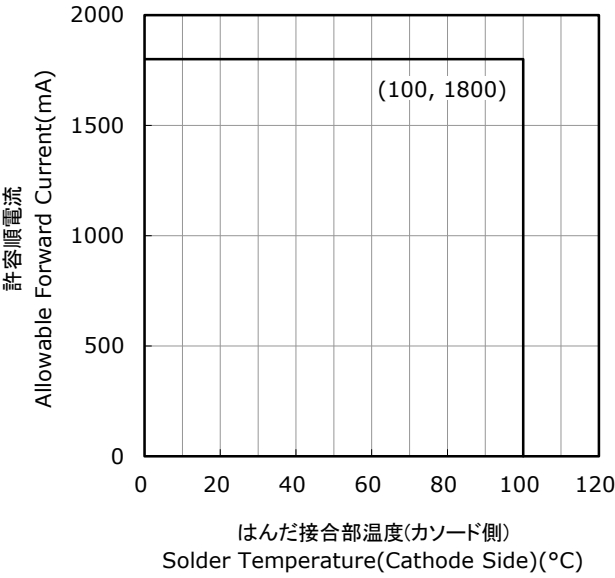
DERATING CHARACTERISTICS

NVSW119D
管理番号 No. STS-DA7-12653

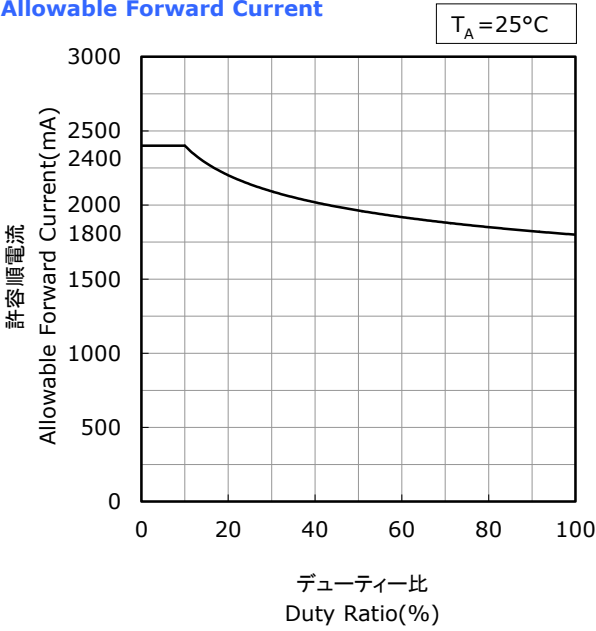
周囲温度-許容順電流特性
Ambient Temperature vs
Allowable Forward Current



はんだ接合部温度(カソード側)-許容順電流特性
Solder Temperature(Cathode Side) vs
Allowable Forward Current



デューティー比-許容順電流特性
Duty Ratio vs
Allowable Forward Current

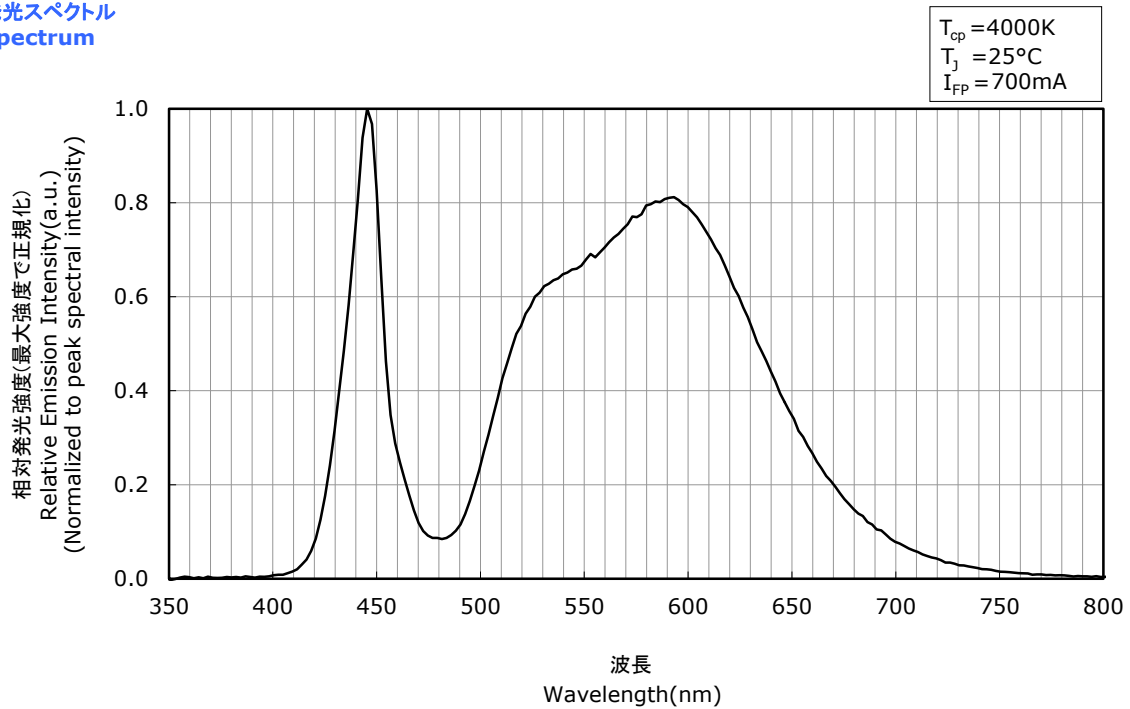


OPTICAL CHARACTERISTICS

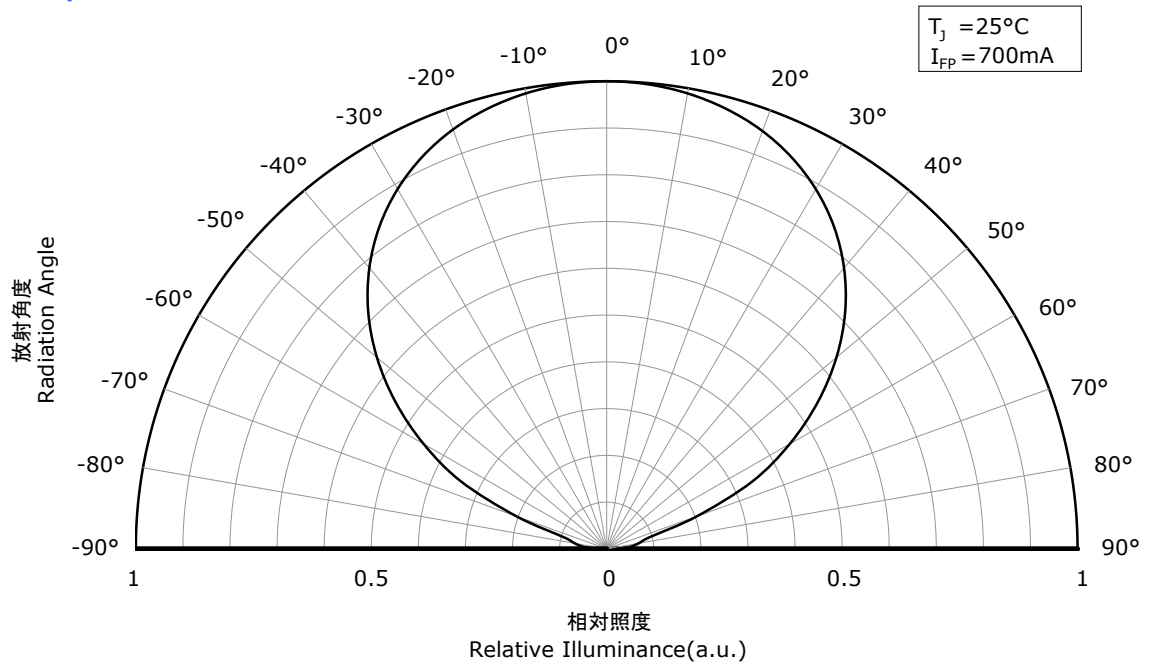
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NVSW119D
管理番号 No. STS-DA7-12641

発光スペクトル
Spectrum



指向特性
Directivity



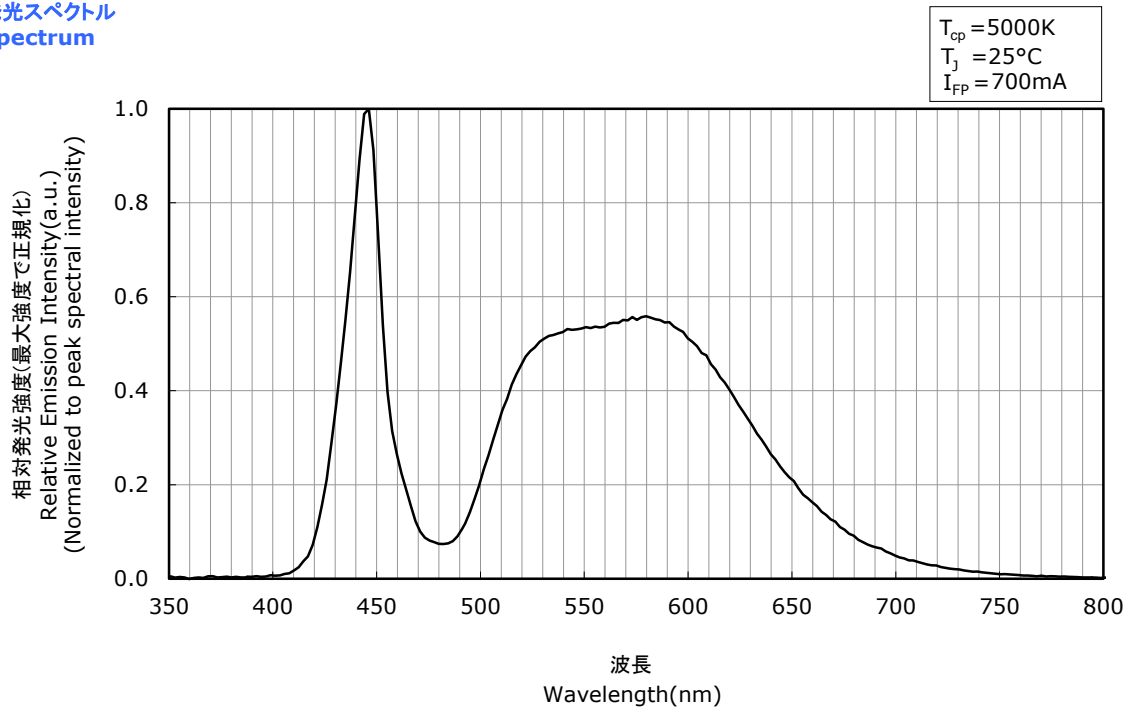
- * 本特性は演色性ランクR70に対応しています。
The graphs above show the characteristics for R70 LEDs of this product.

OPTICAL CHARACTERISTICS

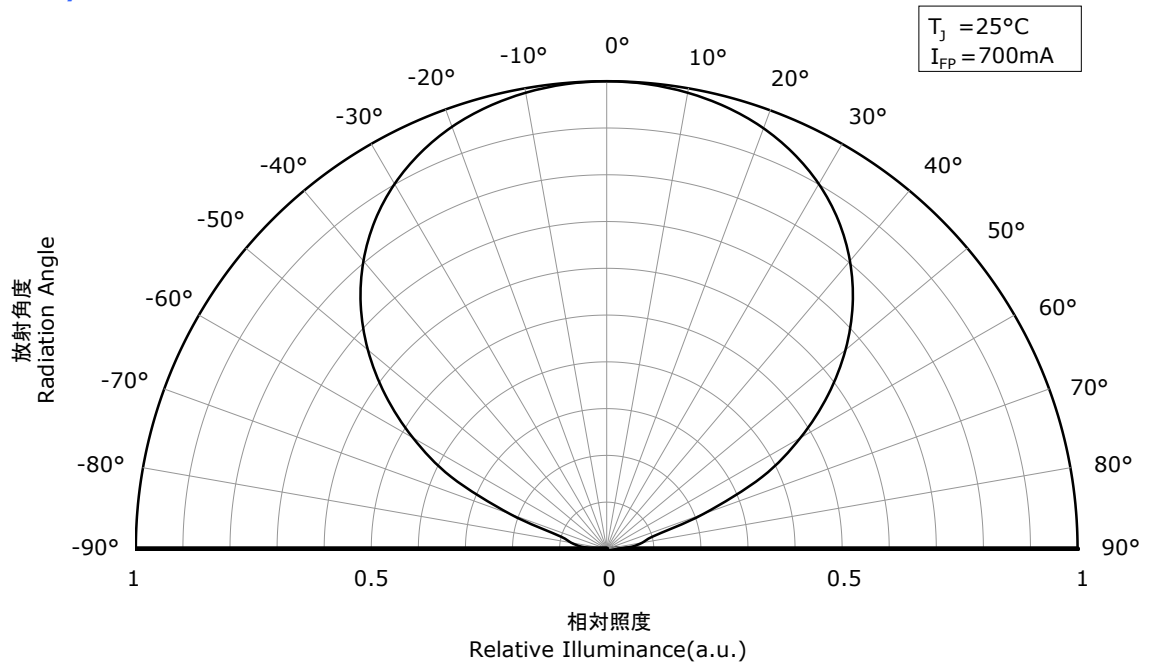
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NVSW119D
管理番号 No. STS-DA7-12642

発光スペクトル
Spectrum



指向特性
Directivity



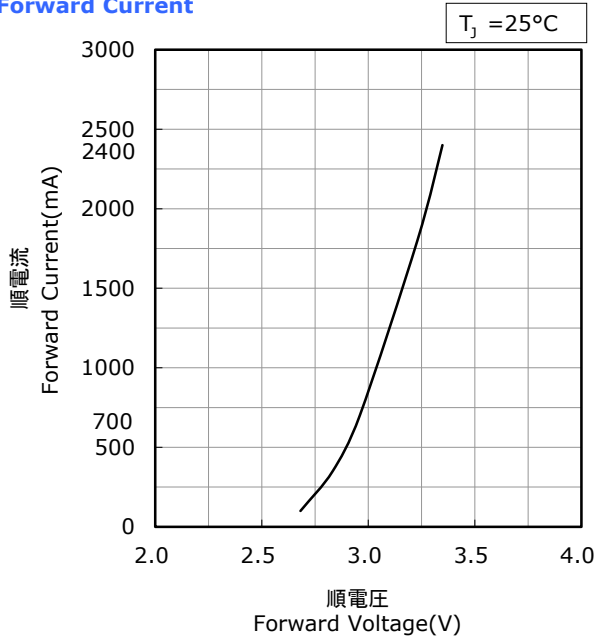
- * 本特性は演色性ランクR70に対応しています。
The graphs above show the characteristics for R70 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

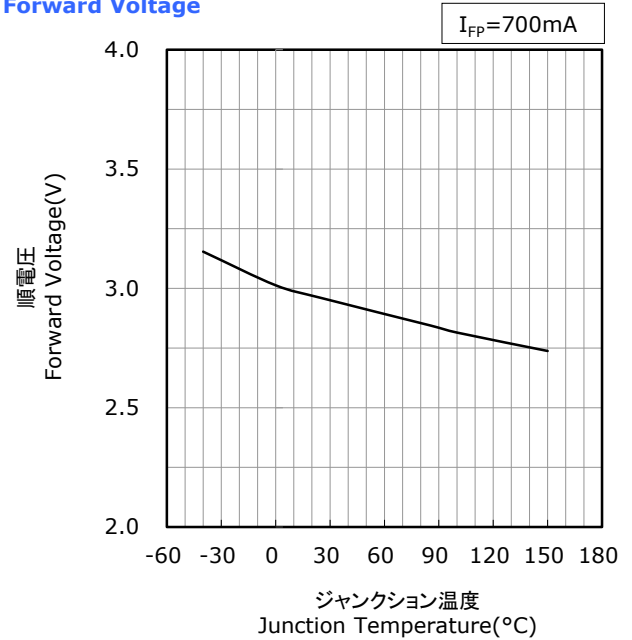
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NVSW119D
管理番号 No. STS-DA7-12643

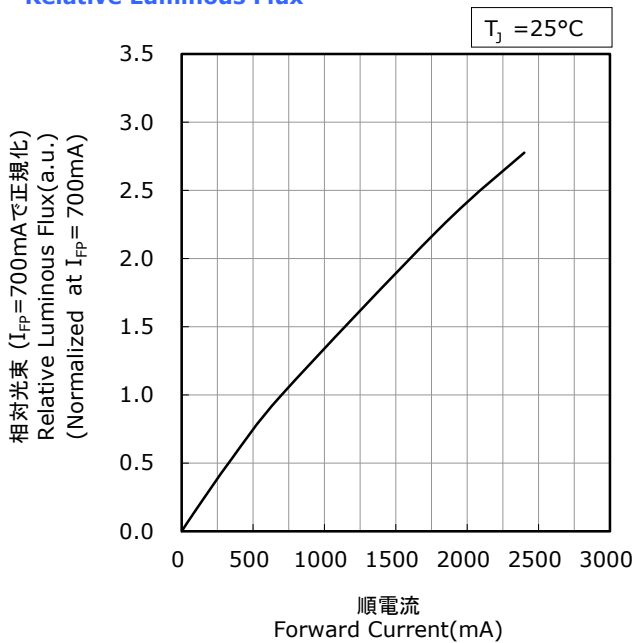
順電圧-順電流特性
Forward Voltage vs
Forward Current



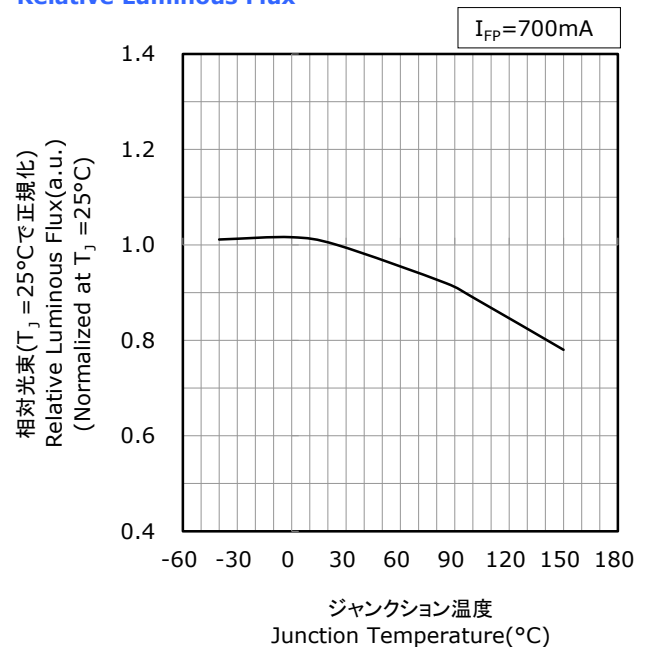
ジャンクション温度-順電圧特性
Junction Temperature vs
Forward Voltage



順電流-相対光束特性
Forward Current vs
Relative Luminous Flux



ジャンクション温度-相対光束特性
Junction Temperature vs
Relative Luminous Flux



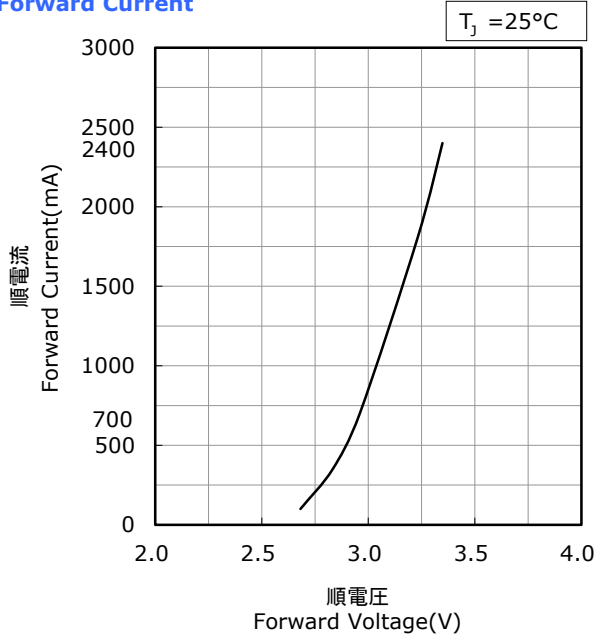
- * 本特性は色温度2700K~4000K、演色性ランクR70に対応しています。
The graphs above show the characteristics for 2700K~4000K, R70 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

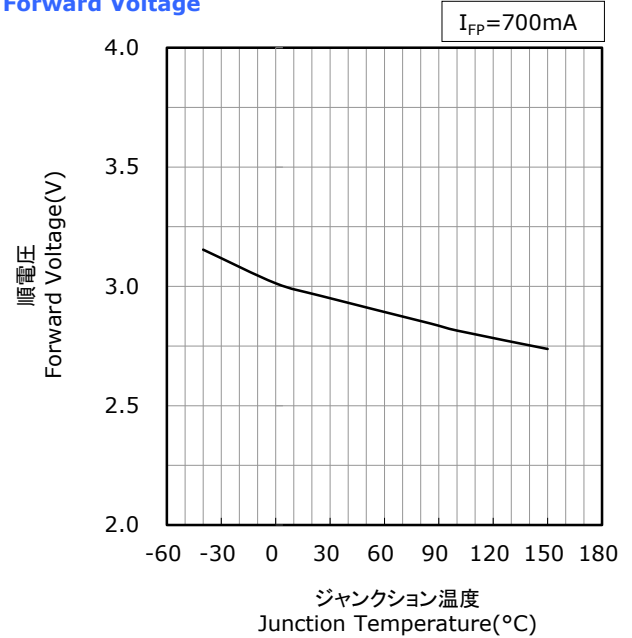
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NVSW119D
管理番号 No. STS-DA7-12644

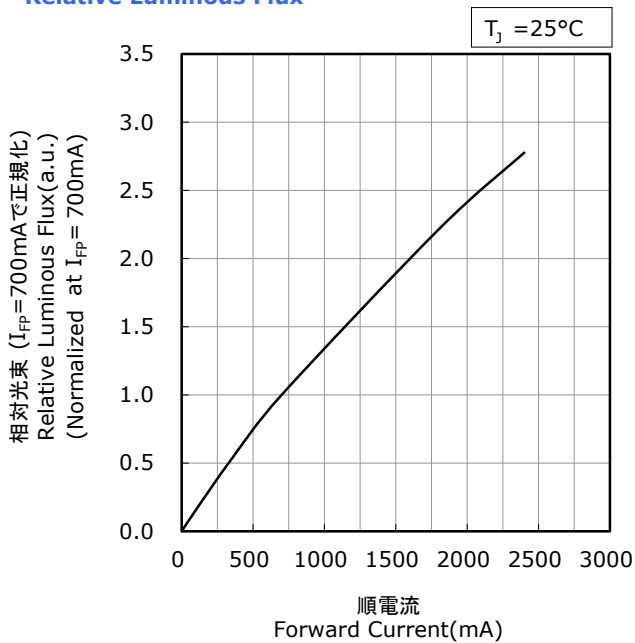
順電圧-順電流特性
Forward Voltage vs
Forward Current



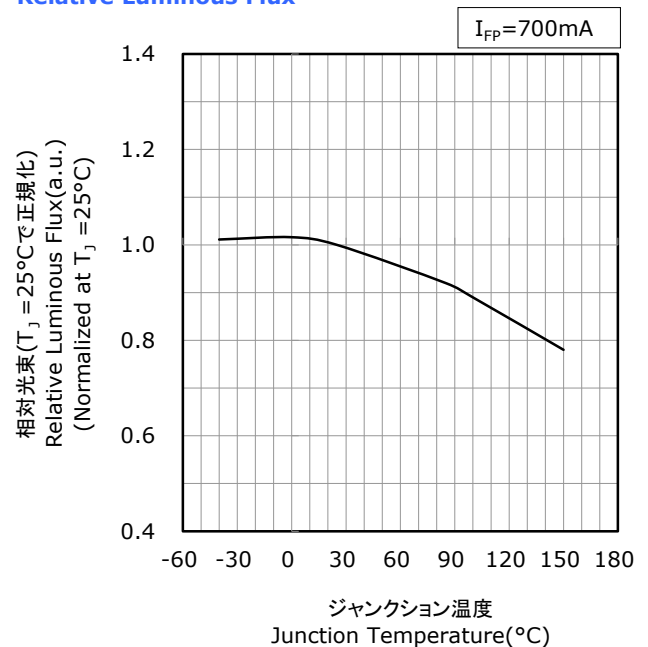
ジャンクション温度-順電圧特性
Junction Temperature vs
Forward Voltage



順電流-相対光束特性
Forward Current vs
Relative Luminous Flux



ジャンクション温度-相対光束特性
Junction Temperature vs
Relative Luminous Flux



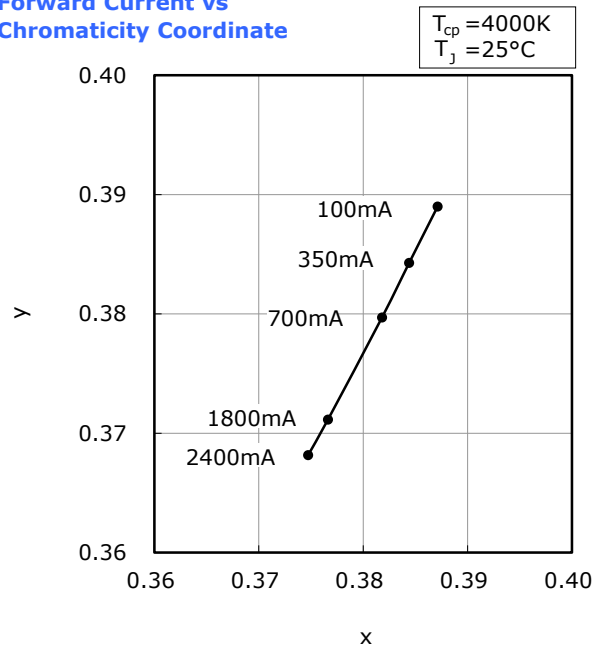
- * 本特性は色温度5000K、演色性ランクR70に対応しています。
The graphs above show the characteristics for 5000K, R70 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

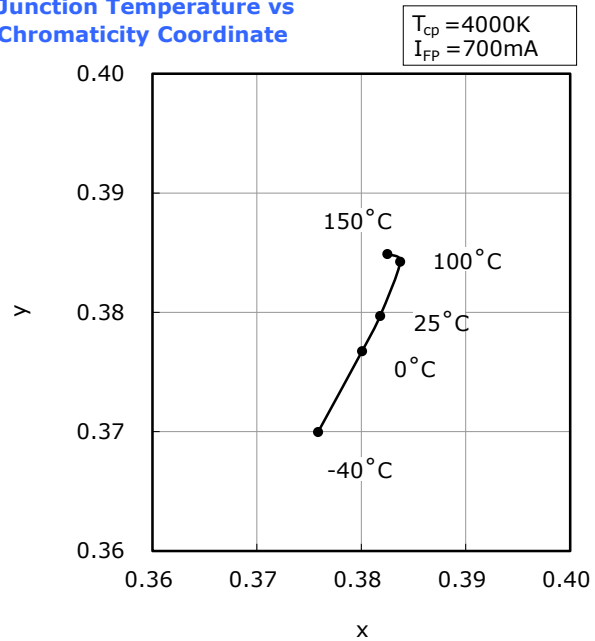
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NVSW119D
管理番号 No. STS-DA7-12645

順電流-色度 特性
Forward Current vs
Chromaticity Coordinate



ジャンクション温度-色度 特性
Junction Temperature vs
Chromaticity Coordinate



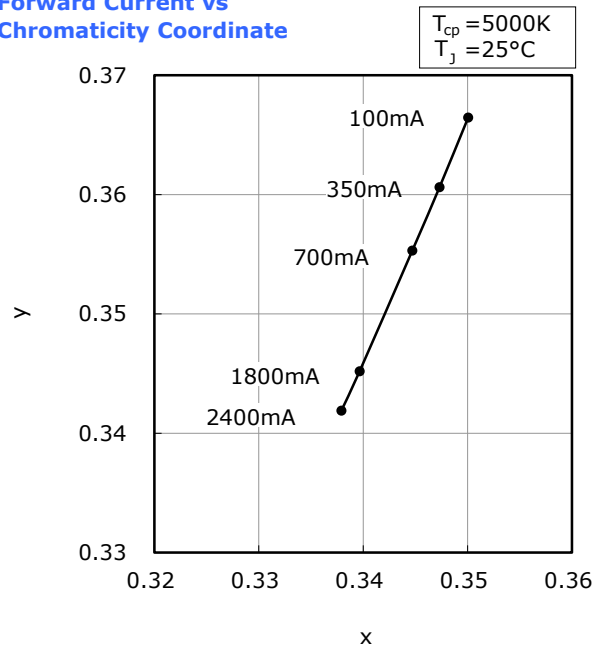
- * 本特性は演色性ランクR70に対応しています。
The graphs above show the characteristics for R70 LEDs of this product.

FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

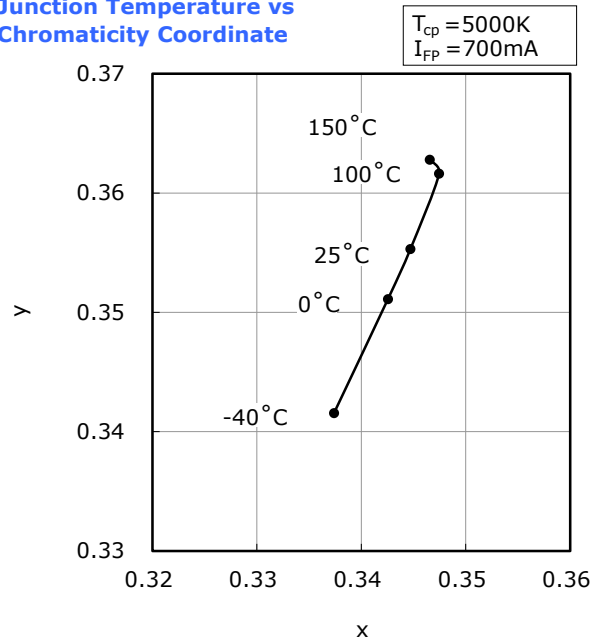
- * 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.
- * パルス駆動により測定しています。
The following graphs show the characteristics measured in pulse mode.

NVSW119D
管理番号 No. STS-DA7-12646

順電流-色度 特性
Forward Current vs
Chromaticity Coordinate



ジャンクション温度-色度 特性
Junction Temperature vs
Chromaticity Coordinate



- * 本特性は演色性ランクR70に対応しています。
The graphs above show the characteristics for R70 LEDs of this product.

RELIABILITY

(1) Tests and Results

Test	Reference Standard	Test Conditions	Test Duration	Failure Criteria #	Units Failed/Tested
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	$T_{\text{slid}}=260^{\circ}\text{C}$, 10sec, 2reflows, Precondition: 30°C , 70%RH, 168hr		#1	0/22
Solderability (Reflow Soldering)	JEITA ED-4701 303 303A	$T_{\text{slid}}=245\pm 5^{\circ}\text{C}$, 5sec, Lead-free Solder(Sn-3.0Ag-0.5Cu)		#2	0/22
Thermal Shock		-40°C to 100°C , 15min dwell	100cycles	#1	0/22
Moisture Resistance (Cyclic)	JEITA ED-4701 200 203	$25^{\circ}\text{C}\sim 65^{\circ}\text{C}\sim -10^{\circ}\text{C}$, 90%RH, 24hr per cycle	10cycles	#1	0/22
High Temperature Storage	JEITA ED-4701 200 201	$T_A=100^{\circ}\text{C}$	1000hours	#1	0/22
Temperature Humidity Storage	JEITA ED-4701 100 103	$T_A=60^{\circ}\text{C}$, RH=90%	1000hours	#1	0/22
Low Temperature Storage	JEITA ED-4701 200 202	$T_A=-40^{\circ}\text{C}$	1000hours	#1	0/22
Room Temperature Operating Life		$T_A=25^{\circ}\text{C}$, $I_F=1000\text{mA}$ Test board: See NOTES below	1000hours	#1	0/22
High Temperature Operating Life		$T_A=100^{\circ}\text{C}$, $I_F=400\text{mA}$ Test board: See NOTES below	1000hours	#1	0/22
Temperature Humidity Operating Life		60°C , RH=90%, $I_F=700\text{mA}$ Test board: See NOTES below	500hours	#1	0/22
Low Temperature Operating Life		$T_A=-40^{\circ}\text{C}$, $I_F=700\text{mA}$ Test board: See NOTES below	1000hours	#1	0/22
Electrostatic Discharges	JEITA ED-4701 300 304	HBM, 2kV, 1.5k Ω , 100pF, 3pulses, alternately positive or negative		#1	0/22

NOTES:

- 1) Test board: FR4 board thickness=1.6mm, copper layer thickness=0.07mm, $R_{\theta JA}\approx 30^{\circ}\text{C/W}$
- 2) Measurements are performed after allowing the LEDs to return to room temperature.

(2) Failure Criteria

Criteria #	Items	Conditions	Failure Criteria
#1	Forward Voltage(V_F)	$I_F=700\text{mA}$	$>\text{Initial value}\times 1.1$
	Luminous Flux(Φ_V)	$I_F=700\text{mA}$	$<\text{Initial value}\times 0.7$
#2	Solderability	-	Less than 95% solder coverage

CAUTIONS

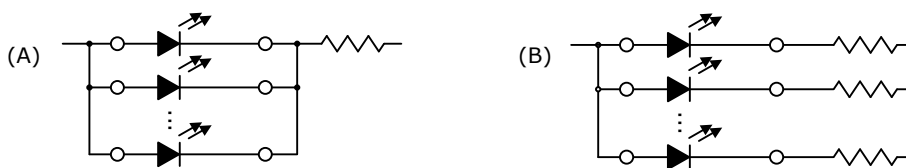
(1) Storage

Conditions		Temperature	Humidity	Time
Storage	Before Opening Aluminum Bag	$\leq 30^{\circ}\text{C}$	$\leq 90\%\text{RH}$	Within 1 Year from Delivery Date
	After Opening Aluminum Bag	$\leq 30^{\circ}\text{C}$	$\leq 70\%\text{RH}$	$\leq 168\text{hours}$
Baking		$65 \pm 5^{\circ}\text{C}$	-	$\geq 24\text{hours}$

- Product complies with JEDEC MSL 3 or equivalent. See IPC/JEDEC STD-020 for moisture-sensitivity details.
- Absorbed moisture in LED packages can vaporize and expand during soldering, which can cause interface delamination and result in optical performance degradation. Products are packed in moisture-proof aluminum bags to minimize moisture absorption during transportation and storage. Included silica gel desiccants change from blue to red if moisture had penetrated bags.
- After opening the moisture-proof aluminum bag, the products should go through the soldering process within the range of the conditions stated above. Unused remaining LEDs should be stored with silica gel desiccants in a hermetically sealed container, preferably the original moisture-proof bags for storage.
- After the "Period After Opening" storage time has been exceeded or silica gel desiccants are no longer blue, the products should be baked. Baking should only be done once.
- Although the leads or electrode pads (anode and cathode) of the product are plated with gold, prolonged exposure to a corrosive environment might cause the gold plated the leads or electrode pads to tarnish, and thus leading to difficulties in soldering. If unused LEDs remain, they must be stored in a hermetically sealed container. Nichia recommends using the original moisture-proof bag for storage.
- Do not use sulfur-containing materials in commercial products. Some materials, such as seals and adhesives, may contain sulfur. The contaminated plating of LEDs might cause an open circuit. Silicone rubber is recommended as a material for seals. Bear in mind, the use of silicones may lead to silicone contamination of electrical contacts inside the products, caused by low molecular weight volatile siloxane.
- To prevent water condensation, please avoid large temperature and humidity fluctuations for the storage conditions.
- Do not store the LEDs in a dusty environment.
- Do not expose the LEDs to direct sunlight and/or an environment where the temperature is higher than normal room temperature.

(2) Directions for Use

- When designing a circuit, the current through each LED must not exceed the Absolute Maximum Rating. Operating at a constant current per LED is recommended. In case of operating at a constant voltage, Circuit B is recommended. If the LEDs are operated with constant voltage using Circuit A, the current through the LEDs may vary due to the variation in Forward Voltage characteristics of the LEDs.



- This product should be operated using forward current. Ensure that the product is not subjected to either forward or reverse voltage while it is not in use. In particular, subjecting it to continuous reverse voltage may cause migration, which may cause damage to the LED die. When used in displays that are not used for a long time, the main power supply should be switched off for safety.
- It is recommended to operate the LEDs at a current greater than 10% of the sorting current to stabilize the LED characteristics.
- Ensure that excessive voltages such as lightning surges are not applied to the LEDs.
- For outdoor use, necessary measures should be taken to prevent water, moisture and salt air damage.

(3) Handling Precautions

- Do not handle the LEDs with bare hands as it will contaminate the LED surface and may affect the optical characteristics: it might cause the LED to be deformed and/or the bump to break, which will cause the LED not to illuminate.
- When handling the product with tweezers, be careful not to apply excessive force to the resin. Otherwise, The resin can be cut, chipped, delaminate or deformed, causing bump-bond breaks and catastrophic failures.
- Dropping the product may cause damage.
- Do not stack assembled PCBs together. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed. It may cause bump to break, leading to catastrophic failures.

(4) Design Consideration

- PCB warpage after mounting the products onto a PCB can cause the package to break. The LED should be placed in a way to minimize the stress on the LEDs due to PCB bow and twist.
- The position and orientation of the LEDs affect how much mechanical stress is exerted on the LEDs placed near the score lines. The LED should be placed in a way to minimize the stress on the LEDs due to board flexing.
- Board separation must be performed using special jigs, not using hands.
- If an aluminum PCB is used, customer is advised to verify the PCB with the products before use. Thermal stress during use can cause the solder joints to crack.
- Volatile organic compounds that have been released from materials present around the LEDs (e.g. housing, packing, adhesive, secondary lens, lens cover, etc.) may penetrate the LED lens and/or encapsulating resin. If the LEDs are being used in a hermetically sealed environment, these volatile compounds can discolor after being exposed to heat and/or photon energy and it may greatly reduce the LED light output and/or cause a color shift. In this case, ventilating the environment may improve the reduction in light output and/or color shift. Perform a light-up test of the chosen application for optical evaluation to ensure that there are no issues, especially if the LEDs are planned to be used in a hermetically sealed environment.

(5) Electrostatic Discharge (ESD)

- The products are sensitive to static electricity or surge voltage. ESD can damage a die and its reliability. When handling the products, the following measures against electrostatic discharge are strongly recommended:
 - Eliminating the charge
 - Grounded wrist strap, ESD footwear, clothes, and floors
 - Grounded workstation equipment and tools
 - ESD table/shelf mat made of conductive materials
- Ensure that tools (e.g. soldering irons), jigs and machines that are being used are properly grounded and that proper grounding techniques are used in work areas. For devices/equipment that mount the LEDs, protection against surge voltages should also be used.
- If tools or equipment contain insulating materials such as glass or plastic, the following measures against electrostatic discharge are strongly recommended:
 - Dissipating static charge with conductive materials
 - Preventing charge generation with moisture
 - Neutralizing the charge with ionizers
- The customer is advised to check if the LEDs are damaged by ESD when performing the characteristics inspection of the LEDs in the application. Damage can be detected with a forward voltage measurement or a light-up test at low current ($\leq 1\text{mA}$).
- ESD damaged LEDs may have current flow at a low voltage or no longer illuminate at a low current.
 - Failure Criteria: $V_F < 2.0\text{V}$ at $I_F = 0.5\text{mA}$

(6) Thermal Management

- Proper thermal management is an important when designing products with LEDs. LED die temperature is affected by PCB thermal resistance and LED spacing on the board. Please design products in a way that the LED die temperature does not exceed the maximum Junction Temperature (T_J).
- Drive current should be determined for the surrounding ambient temperature (T_A) to dissipate the heat from the product.
- The following equations can be used to calculate the LED temperature (i.e. T_J) once the saturation temperature at the junction has been reached.

$$1) T_J = T_A + R_{\theta JA} \cdot W \quad 2) T_J = T_S + R_{\theta JS} \cdot W$$

* T_J =LED junction temperature: °C

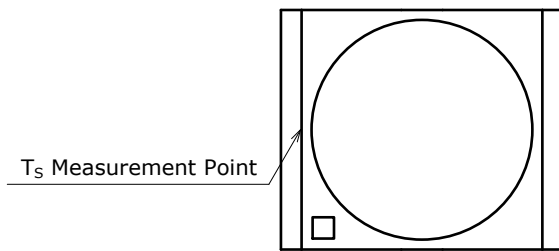
T_A =Ambient temperature: °C

T_S =Soldering temperature (cathode side): °C

$R_{\theta JA}$ =Thermal resistance from junction to ambient: °C/W

$R_{\theta JS}$ =Thermal resistance from junction to T_S measurement point: °C/W

W =Input power($I_F \times V_F$): W



(7) Cleaning

- The LEDs should not be cleaned with water, benzine, and/or thinner.
- If required, isopropyl alcohol (IPA) should be used. Other solvents may cause premature failure to the LEDs due to the damage to the resin portion. The effects of such solvents should be verified prior to use. In addition, the use of CFCs such as Freon is heavily regulated.
- When dust and/or dirt adheres to the LEDs, soak a cloth with Isopropyl alcohol (IPA), then squeeze it before wiping the LEDs.
- Ultrasonic cleaning is not recommended since it may have adverse effects on the LEDs depending on the ultrasonic power and how LED is assembled. If ultrasonic cleaning must be used, the customer is advised to make sure the LEDs will not be damaged prior to cleaning.

(8) Eye Safety

- In 2006, the International Electrical Commission (IEC) published IEC 62471:2006 Photobiological safety of lamps and lamp systems, which added LEDs in its scope. On the other hand, the IEC 60825-1:2007 laser safety standard removed LEDs from its scope. However, please be advised that some countries and regions have adopted standards based on the IEC laser safety standard IEC 60825-1:20112001, which still includes LEDs in its scope. Most of Nichia's LEDs can be classified as belonging into either the Exempt Group or Risk Group 1. High-power LEDs, that emit light containing blue wavelengths, may be classified as Risk Group 2. Please proceed with caution when viewing directly any LEDs driven at high current, or viewing LEDs with optical instruments which may greatly increase the damages to your eyes.
- Viewing a flashing light may cause eye discomfort. When incorporating the LED into your product, please be careful to avoid adverse effects on the human body caused by light stimulation.

(9) Miscellaneous

- Nichia warrants that the discrete LEDs will meet the requirements/criteria as detailed in the Reliability section within this specification. If the LEDs are used under conditions/environments deviating from or inconsistent with those described in this specification, the resulting damage and/or injuries will not be covered by this warranty.
- Nichia warrants that the discrete LEDs manufactured and/or supplied by Nichia will meet the requirements/criteria as detailed in the Reliability section within this specification; it is the customer's responsibility to perform sufficient verification prior to use to ensure that the lifetime and other quality characteristics required for the intended use are met.
- The applicable warranty period is one year from the date that the LED is delivered. In the case of any incident that appears to be in breach of this warranty, the local Nichia sales representative should be notified to discuss instructions on how to proceed while ensuring that the LED in question is not disassembled or removed from the PCB if it has been attached to the PCB. If a breach of this warranty is proved, Nichia will provide the replacement for the non-conforming LED or an equivalent item at Nichia's discretion. FOREGOING ARE THE EXCLUSIVE REMEDIES AVAILABLE TO THE CUSTOMER IN RESPECT OF THE BREACH OF THE WARRANTY CONTAINED HEREIN, AND IN NO EVENT SHALL NICHIA BE RESPONSIBLE FOR ANY INDIRECT, INCIDENTAL OR CONSEQUENTIAL LOSSES AND/OR EXPENSES (INCLUDING LOSS OF PROFIT) THAT MAY BE SUFFERED BY THE CUSTOMER ARISING OUT OF A BREACH OF THE WARRANTY.
- NICHIA DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, INCLUDING THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.
- This LED is intended to be used for general lighting, household appliances, electronic devices (e.g. mobile communication devices); it is not designed or manufactured for use in applications that require safety critical functions (e.g. aircraft, automobiles, combustion equipment, life support systems, nuclear reactor control system, safety devices, spacecraft, submarine repeaters, traffic control equipment, trains, vessels, etc.). If the LEDs are planned to be used for these applications, unless otherwise detailed in the specification, Nichia will neither guarantee that the LED is fit for that purpose nor be responsible for any resulting property damage, injuries and/or loss of life/health. This LED does not comply with ISO/TS 16949 and is not intended for automotive applications.
- The customer will not reverse engineer, disassemble or otherwise attempt to extract knowledge/design information from the LED.
- All copyrights and other intellectual property rights in this specification in any form are reserved by Nichia or the right holders who have granted Nichia permission to use the content. Without prior written permission from Nichia, no part of this specification may be reproduced in any form or by any means.
- Both the customer and Nichia will agree on the official specifications for the supplied LEDs before any programs are officially launched. Without this agreement in writing (i.e. Customer Specific Specification), changes to the content of this specification may occur without notice (e.g. changes to the foregoing specifications and appearance, discontinuation of the LEDs, etc.).